TI Designs TIDA-01243 USB Type-CTM Mini Dock



Design Overview

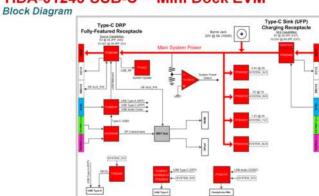
The USB-C™ mini dock board is a docking system that can support additional functions to the basic USB transfers with default VBUS over a USB-C™ connection. This board features USB3.1 (Gen1) data, DisplayPort video transfers and charging up to 20V at 3A, all over a single USB-C™ cable connection; additionally, it includes a protocol converter to support different video data types (DisplayPort and HDMI)

- Data, audio and video port expansion.
- The dock can provide up to 20V @3A through Type-C connection
- The dock provides multiple USB DFP connectors for Type-C and legacy USB operation.
- The Dual Role Type-C port of the dock can be connected directly to a Type-C Notebook or tablet systems.
- Video and power delivery can be enabled over the Type-C connection.

Design Resources

TIDA-0143 HD3SS460 TPS53318 TPS54331 TLV3012 TPD6E05U06 TPD4E05U06 TVSB8041 TPD13S523 TPS3831K33 TPS2500 TPS54332 PCM2707C TPS65982 CSD87501L HD3SS3212 TPS25910 TPS65986 TUSB321 TUSB3410	Tool Folder Product Folder
<u>TPS2013A</u>	Product Folder

Block Diagram TIDA-01243 USB-C™ Mini Dock EVM



Design Features

- Feature #1 Bi-Directional Power Capabilities
- Feature #2 Includes a USB3 hub TUSB8041 for USB port expansion
- Feature #3 Dual Video (up to 4K) via HDMI or miniDP
- Feature #4 Flash Update over Type-C via USB 2.0 EndPoint

Featured Applications

 Application #1 Designed to help evaluate Type-C Dock implementations with audio, video and charging support.

Board Image





1 System Description

The USB-C™ mini dock board is a docking system that can support additional functions to the basic USB transfers with default VBUS over a USB-C™ connection. This board features USB3.1 (Gen1) data, DisplayPort video transfers and charging up to 20V at 3A, all over a single USB-C™ cable connection; additionally, it includes a protocol converter to support different video data types (DisplayPort and HDMI)

1.1 HD3SS460 USB Type-CTM Alternate Mode 4x6 Differential Switch

The HD3SS460 is a high-speed bi-directional passive 4-6 cross-point switch in mux or demux configurations. Based on control pin POL the device provides switching to accommodate USB Type-C plug flipping. The device provides multiple signal switching options that allow system implementation flexibility. The HD3SS460 is a generic analog, differential passive switch that can work for any high speed interface applications as long as it is biased at a common mode voltage range of 0-2 V and has differential signaling with differential amplitude up to 1800 mVpp. It employs an adaptive tracking that ensures the channel remains unchanged for entire common mode voltage range Excellent dynamic characteristics of the device allow high speed switching with minimum attenuation to the signal eye diagram with very little added jitter.



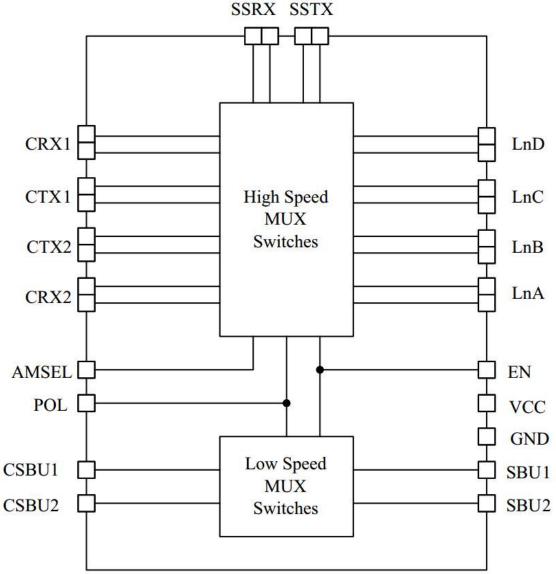


Figure 1: HD3SS460

1.2 TPS53318 High-Efficiency 8-A Synchronous Buck Converter with Eco-mode[™]

The TPS53318 and TPS53319 devices are D-CAP mode, 8-A or 14-A synchronous switchers with integrated MOSFETs. They are designed for ease of use, low external component count, and spaceconscious power systems.

These devices feature accurate 1%, 0.6-V reference and integrated boost switch. A sample of competitive features include: 1.5-V to 22-V wide conversion input voltage range, very low external component count, D-CAP™ mode control for super fast transient, auto-skip mode operation, internal soft-start control, selectable frequency, and no need for compensation.

The conversion input voltage ranges from 1.5 V to 22 V, the supply voltage range is from 4.5 V to 25 V and the output voltage range is from 0.6 V to 5.5 V.



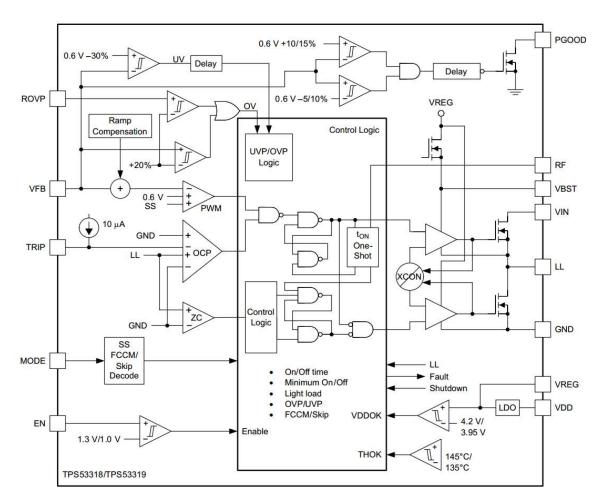


Figure 3: TPS53318

1.3 TPS54331 3.5 To 28V Input, 3A 570kHz Step-Down Converter with Eco-modeTM

The TPS54331 device is a 28-V, 3-A non-synchronous buck converter that integrates a low RDS(on) high-side MOSFET. To increase efficiency at light loads, a pulse skipping Eco-mode feature is automatically activated. Furthermore, the 1-µA shutdown supply-current allows the device to be used in battery-powered applications. Current mode control with internal slope compensation simplifies the external compensation calculations and reduces component count while allowing the use of ceramic output capacitors. A resistor divider programs the hysteresis of the input undervoltage lockout. An overvoltage transient protection circuit limits voltage overshoots during startup and transient conditions. A cycle-by-cycle current-limit scheme, frequency foldback and thermal shutdown protect the device and the load in the event of an overload condition. The TPS54331 device is available in an 8-pin SOIC package and 8-pin SO PowerPAD package that have been internally optimized to improve thermal performance.



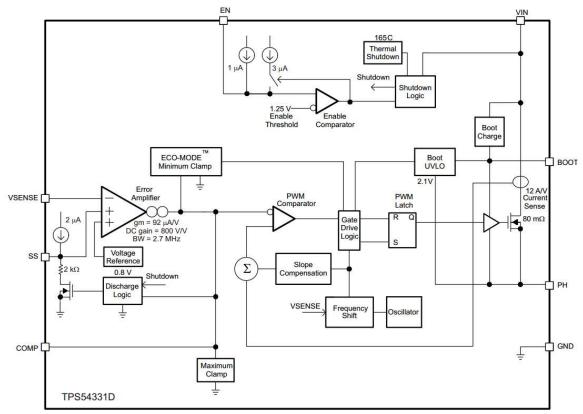


Figure 3: TPS54331

1.4 TLV3012 Nanopower, 1.8V, SOT23 Push-pull Comparator with Voltage Reference

The TLV3011 is a low-power, open-drain output comparator; the TLV3012 is a push-pull output comparator. Both feature an uncommitted on-chip voltage reference. Both have 5μ A (max) quiescent current, input common-mode range 200mV beyond the supply rails, and single-supply operation from 1.8V to 5.5V. The integrated 1.242V series voltage reference offers low 100ppm/°C (max) drift, is stable with up to 10nF capacitive load, and can provide up to 0.5mA (typ) of output current. The TLV3011 and TLV3012 are available in the tiny SOT23-6 package for the most space-conservative designs. It is also available in the SC70 package for even greater board area savings. Both versions are specified for the temperature range of -40° C to $+125^{\circ}$ C.



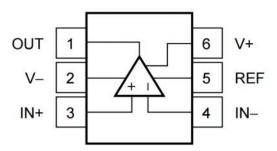


Figure 4: TLV3011

1.5 TPD6E05U06 6-Channel Ultra Low Capacitance IEC ESD Protection Diodes

The TPDxE05U06 is a family of unidirectional Transient Voltage Suppressor (TVS) based Electrostatic Discharge (ESD) protection diodes with ultra-low capacitance. Each device can dissipate ESD strikes above the maximum level specified by the IEC 61000-4-2 international standard. The TPDxE05U06's ultra-low loading capacitance makes it ideal for protecting any high-speed signal pins.

Typical applications for TPDxE05U06 includes high speed signal lines in HDMI 1.4, HDMI 2.0, USB 3.0, MHL, LVDS, DisplayPort, PCI-Express, eSata, and V-by-One HS.

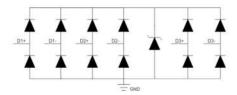


Figure 5: TPD6E05U06

1.6 TPD4E05U06 4-Channel Ultra Low Capacitance IEC ESD Protection Diodes

The TPDxE05U06 is a family of unidirectional Transient Voltage Suppressor (TVS) based Electrostatic Discharge (ESD) protection diodes with ultra-low capacitance. Each device can dissipate ESD strikes above the maximum level specified by the IEC 61000-4-2 international standard. The TPDxE05U06's ultra-low loading capacitance makes it ideal for protecting any high-speed signal pins.

Typical applications for TPDxE05U06 includes high speed signal lines in HDMI 1.4, HDMI 2.0, USB 3.0, MHL, LVDS, DisplayPort, PCI-Express, eSata, and V-by-One HS.



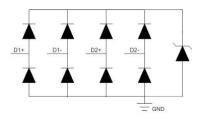


Figure 6: TPD4E05U06

1.7 TUSB8041 4-Port SuperSpeed 5.0 Gbps USB 3.0 Hub

The TUSB8041 is a four-port USB 3.0 hub. It provides simultaneous SuperSpeed USB and high-speed/full-speed connections on the upstream port and provides SuperSpeed USB, high-speed, full-speed, or low-speed connections on the downstream ports. When the upstream port is connected to an electrical environment that only supports high-speed or full-speed/low-speed connections, SuperSpeed USB connectivity is disabled on the downstream ports. When the upstream port is connected to an electrical environment that only supports full-speed/low-speed connections, SuperSpeed USB and high-speed connectivity are disabled on the downstream ports.

The TUSB8041 supports per port or ganged power switching and over-current protection, and supports battery charging applications.

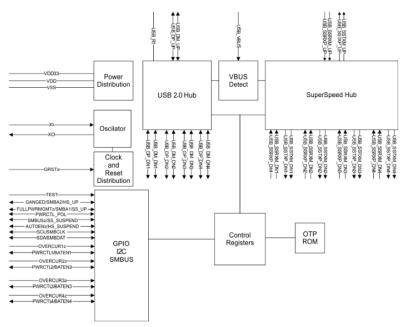


Figure 7: TUSB8041

1.8 TPD13S523 13-Channel HDMI Port Solution With Protection and Current-Limit Load Switch

The TPD13S523 device is a single-chip integrated IEC 61000-4-2 ESD protection solution for HDMI 1.4 or HDMI 1.3 interfaces. This device offers 13 channels of TVS diodes with flow-through pin mapping that matches HDMI connector high-speed lines. While providing ESD protection, the TPD13S523 adds little to no additional distortion to the high-speed differential signals. The monolithic integrated circuit technology ensures that there is excellent matching between the two-signal pair of



the differential line (< 0.05-pF differential matching between TMDS lines). This offers an advantage over discrete ESD solutions where variations between two different ESD protection circuits may significantly degrade the differential signal quality.

The TPD13S523 incorporates an on-chip current limited load switch that is compliant with HDMI 5-V out electrical specifications. The short-circuit protection at 5V_OUT ensures that the device is not damaged in case there is an accidental short to GND. The load switch also incorporates a reverse-current blocking feature which ensures that the HDMI driver side is not erroneously turned on when two HDMI drivers are connected together.

Typical applications for the TPD13S523 include set top boxes (STB), e-books, tablets, smart phones, and camcorders.

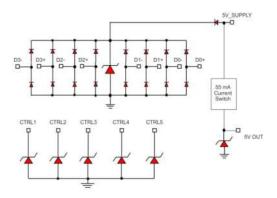


Figure 8: TPD13S523

1.9 TPS3831K33 Ultra-Low 150nA, Ultra-small Voltage Supervisor

The TPS3831 and TPS3839 devices (both referred to as *TPS383x*) are ultralow current (150 nA, typical), voltage supervisory circuits that monitor a single voltage. Both devices initiate an active-low reset signal whenever the VDD supply voltage drops below the factory-trimmed reset threshold voltage. The reset output remains low for 200 ms (typical) after the VDD voltage rises above the threshold voltage and hysteresis. These devices are designed to ignore fast transients on the VDD pin. The TPS3831 device includes a manual reset input that forces RESET low when MR is low. The ultralow current consumption of 150 nA makes these voltage supervisors ideal for use in low-power and portable applications. The TPS383x devices are specified to have the correct output logic state for supply voltages down to 0.6 V.

The TPS383x devices feature precision factory-trimmed threshold voltages and extremely low-power operation. The TPS3831 device is available in a 4-pin, 1-mm × 1-mm (DQN) X2SON package. The TPS3839 device is available in a 3-pin SOT23 (DBZ) package or a 4-pin, 1-mm × 1-mm (DQN) X2SON package

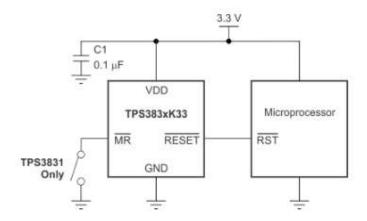


Figure 9: TPS3831K33

1.10 TPS2500 Integrated USB Power Switch with Boost Converter

The TPS2500 and TPS2501 provide an integrated solution to meet USB 5-V power requirements from a 1.8-V to 5.25-V input supply. The features include a Hi-Speed USB compliant power output, output switch enable, current limit, and overcurrent fault reporting.

The 1.8-V to 5.25-V input can be supplied by sources including dc/dc regulated supplies (e.g., 3.3 V), or batteries such as single-cell Li+ or three-cell NiCd, NiMH, or alkaline.

The USB power-switch current limit is programmable via an external resistor from as low as 130 mA to as high as 1400 mA (typical). Two standard USB ports can be supported from a single TPS2500 or TPS2501 at the 1400-mA setting.

Additionally, the boost converter output is available as an auxiliary 5.1-V output to power additional loads. The total current supplied by the USB output and the auxiliary cannot exceed 1148 mA at VIN = 3 V.

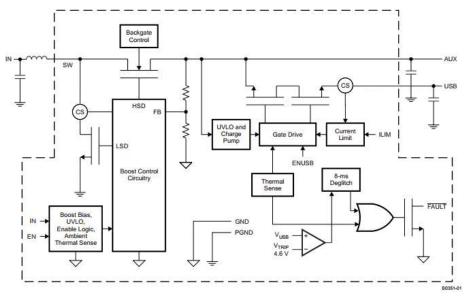


Figure 10: TPS2500



1.11 TPS54332 3.5V to 28V Input, 3.5A, 1MHz Step-Down Converter with Eco-model

The TPS54332 is a 28-V, 3.5-A non-synchronous buck converter that integrates a low-RDS(on) high-side MOSFET. To increase efficiency at light loads, a pulse-skipping Eco-Mode feature is automatically activated. Furthermore, the 1-µA shutdown supply current allows the device to be used in battery-powered applications. Current mode control with internal slope compensation simplifies the external compensation calculations and reduces component count while allowing the use of ceramic output capacitors. A resistor divider programs the hysteresis of the input undervoltage lockout. An overvoltage transient protection circuit limits voltage overshoots during start-up and transient conditions. A cycle-by-cycle current limit scheme, frequency foldback and thermal shutdown protect the device and the load in the event of an overload condition. The TPS54332 is available in an 8-pin SOIC PowerPAD™ package.

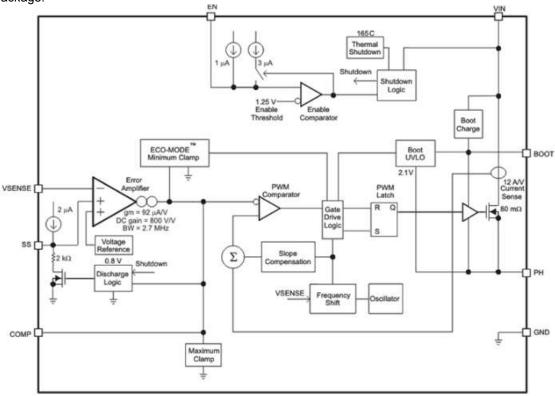


Figure 11: TPS54332



1.12 PCM2707C Stereo Audio DAC with Full Speed USB Interface, Single-Ended Headphone Output, and S/PDIF

The PCM270xC are TI's single-chip USB stereo audio digital-to-analog converters (DACs) with USB 2.0 compliant full-speed protocol controller and S/PDIF. The USB-protocol controller works with no software code, but USB descriptors can be modified in some areas (for example, vendor ID/product ID) through the use of an external ROM (PCM2704C and PCM2706C) or serial peripheral interface (SPI) (PCM2705C and PCM2707C). The PCM270xC also employ SpAct architecture, TI's unique system that recovers the audio clock from USB packet data. On-chip analog phase-locked loops (PLLs) with SpAct enable playback with low clock jitter.

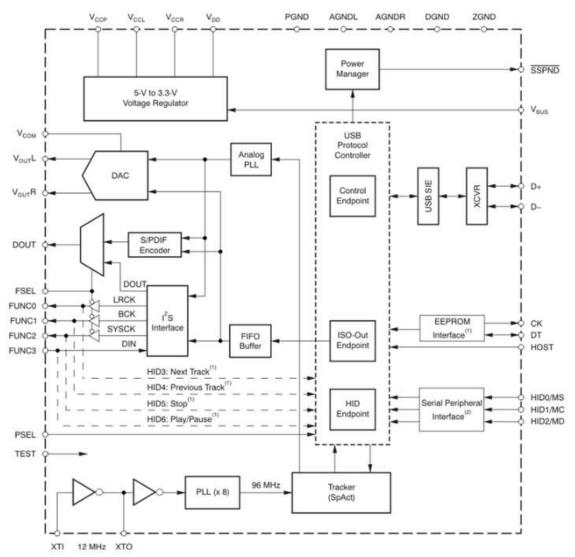


Figure 12: PCM2707C



1.13 TPS65982 USB Type-C & USB PD Controller Power Switch & High Speed Multiplexer

The TPS65982 device is a stand-alone USB Type-C and power delivery (PD) controller providing cable-plug and orientation detection at the USB Type-C connector. Upon cable detection, the TPS65982 device communicates on the CC wire using the USB PD protocol. After successful USB PD negotiation is complete, the TPS65982 enables the appropriate power path and configures alternate mode settings for internal and (optional) external multiplexers.

The mixed-signal front end on the CC pins advertises default, 1.5 A or 3 A for USB Type-C power sources, detects a plug event and determines the Type-C cable orientation, and autonomously negotiates USB PD contracts using bi-phase marked coding (BMC) and the physical layer (PHY) protocol.

The port power switch provides up to 3 A downstream at 5 V for legacy and Type-C USB power. An additional bidirectional switch path provides USB PD power up to 3 A at a maximum of 20 V as either a source (host), sink (device), or source-sink.

The TPS65982 is also an upstream-facing port (UFP), downstream-facing port (DFP), or dual-role port for data. The port data multiplexer passes data to or from the top or bottom D+/D- signal pair at the port for USB 2.0 HS; additionally, the Sideband-Use (SBU) signal pair is used for Alternate Modes. The power management circuitry supports dead battery or no-battery operation using VBUS as a primary power supply when 3.3 V is not available.

For all available packages, see the orderable addendum at the end of the data sheet

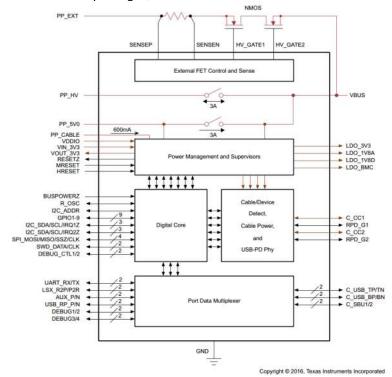


Figure 13: TPS65982



1.14 CSD87501L 30-V Dual N-Channel Common Drain NexFET[™] Power MOSFET

This 30 V, 6.6 m Ω , 3.37 mm × 1.47 mm LGA Dual NexFETTM power MOSFET is designed to minimize resistance and gate charge in a small footprint. Its small size and common drain configuration make the device ideal for multi-cell battery pack applications and small handheld devices.

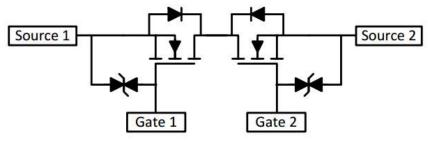


Figure 3: CSD87501L

1.15 HD3SS3212 Two Channel Differential 2:1/1:2 10Gbps Mux/Demux

The HD3SS3212 is a high-speed bidirectional passive switch in mux or demux configurations suited for USB Type-C[™] application supporting USB 3.1 Gen 1 and Gen 2 data rates. Based on control pin SEL, the device provides switching on differential channels between Port B or Port C to Port A.

The HD3SS3212 is a generic analog differential passive switch that can work for any high-speed interface applications requiring a common mode voltage range of 0 to 2 V and differential signaling with differential amplitude up to 1800 mVpp. It employs adaptive tracking that ensures the channel remains unchanged for the entire common mode voltage range.

Excellent dynamic characteristics of the device allow high-speed switching with minimum attenuation to the signal eye diagram with very little added jitter. It consumes <2 mW of power when operational and has a shutdown mode exercisable by OEn pin resulting <20 μ W.

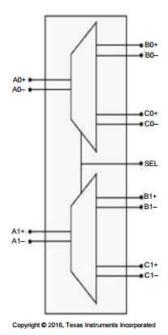


Figure 15: HD3SS3212



1.16 TPS25910 20V, 6.5A, 30M Ω eFuse With Adjustable +/-15% Accurate Current Limit

The TPS25910 device provides highly integrated hot-swap power management and superior protection in applications up to 20 V. The maximum UV turn-on threshold of 2.9 V makes the TPS25910 device well suited to standard bus voltages as low as 3.3 V. This device is intended for systems where a voltage bus must be protected from undesired permanent and transient overload.

At start-up or when hot plugging into the system bus, the TPS25910 device limits the inrush current by controlling the ramp rate of the output voltage, VOUT. The slew rate of VOUT can be adjusted with a capacitor between the GATE pin and the GND pin.

Built in SOA protection ensures that the internal MOSFET operates inside a safe operating area (SOA) under the harshest operating conditions. In addition, the current-limit threshold, which is independent of the power limit, can be adjusted with a resistor between the ILIM pin and the GND pin. The TPS25910 device provides a fault indicator output when in thermal fault.

The TPS25910 device is available in a 16-pin QFN package.

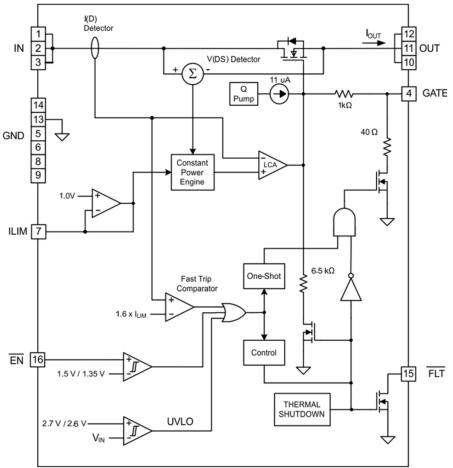


Figure 16: TPS25910



1.17 TPS65986 usb Type-C & USB PD Controller & Power Switch

The TPS65986 is a stand-alone USB Type-C and Power Delivery (PD) controller providing cable plug and orientation detection at the USB Type-C connector. Upon cable detection, the TPS65986 communicates on the CC wire using the USB PD protocol. When cable detection and USB PD negotiation are complete, the TPS65986 enables the appropriate power path and configures alternate mode settings for (optional) external multiplexers.

The mixed-signal front end on the CC pins advertises default (900 mA), 1.5 A, or 3 A for Type-C power sources, detects a plug event and determines the USB Type-C cable orientation, and autonomously negotiates USB PD contracts by adhering to the specified bi-phase marked coding (BMC) and physical layer (PHY) protocol.

The port power switch passes up to 3 A downstream at 5 V for legacy and Type-C USB power. An additional bi-directional switch path provides USB PD power up to 3 A at a maximum of 20 V as either a source (host), sink (device), or source-sink.

The TPS65986 is also an Upstream-Facing Port (UFP), Downstream-Facing Port (DFP), or Dual-Role Port for data. The port data termination passes data to or from the top or bottom D+/D- signal pair to the USB 2.0 Low Speed Endpoint. The power management circuitry can utilizes a 3.3-V power supply inside the system and also uses VBUS to start up and negotiate power from a dead battery or no battery condition.

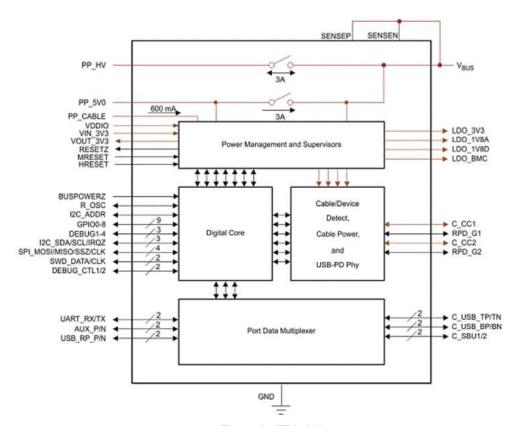


Figure 17: TP65986



1.18 TUSB321 USB Type-C Configuration Channel Logic and Port Control with VCONN

The TUSB321 device enables USB Type-C ports with the configuration channel (CC) logic needed for Type-C ecosystems. The TUSB321 device uses the CC pins to determine port attach and detach, cable orientation, role detection, and port control for Type-C current mode. The TUSB321 device can be configured as a downstream facing port (DFP), upstream facing port (UFP) or a dual role port (DRP) making it ideal for any application.

The TUSB321 device when configured as a DRP alternates configuration as a DFP or UFP according to the Type-C Specifications. The CC logic block monitors the CC1 and CC2 pins for pullup or pulldown resistances to determine when a USB port has been attached, the orientation of the cable, and the role detected. The CC logic detects the Type-C current mode as default, medium, or high depending on the role detected. V_{BUS} detection is implemented to determine a successful attach in UFP and DRP modes.

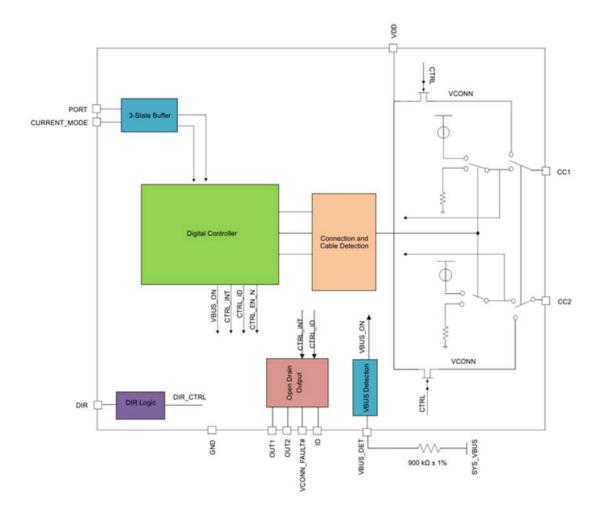


Figure 18: TPS25910



1.19 TUSB3410 UART/I2C/IrDA Serial Port to USB Bridge

The TUSB3410 device provides bridging between a USB port and an enhanced UART serial port. The device contains an 8052 microcontroller unit (MCU) with 16KB of RAM that can be loaded from the host or from the external onboard memory through an I²C. The device also contains 10KB of ROM that allows the MCU to configure the USB port at boot time. The ROM code also contains an I²C bootloader. All device functions (such as the USB command decoding, UART setup, and error reporting) are managed by the internal MCU firmware in unison with the PC host.

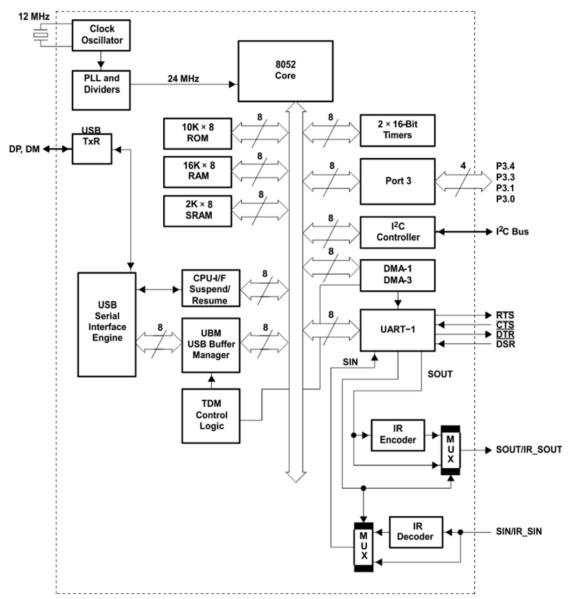


Figure 19: TUSB3410



1.20 TPS2013A

The TPS201xA family of power distribution switches is intended for applications where heavy capacitive loads and short circuits are likely to be encountered. These devices are 50-m N-channel MOSFET high-side power switches. The switch is controlled by a logic enable compatible with 5-V logic and 3-V logic. Gate drive is provided by an internal charge pump designed to control the power-switch rise times and fall times to minimize current surges during switching. The charge pump requires no external components and allows operation from supplies as low as 2.7 V.

When the output load exceeds the current-limit threshold or a short is present, the TPS201xA limits the output current to a safe level by switching into a constant-current mode. When continuous heavy overloads and short circuits increase the power dissipation in the switch, causing the junction temperature to rise, a thermal protection circuit shuts off the switch to prevent damage. Recovery from a thermal shutdown is automatic once the device has cooled sufficiently. Internal circuitry ensures the switch remains off until valid input voltage is present.

The TPS201xA devices differ only in short-circuit current threshold. The TPS2010A limits at 0.3-A load, the TPS2011 at 0.9-A load, the TPS2012A at 1.5-A load, and the TPS2013A at 2.2-A load (see Available Options). The TPS201xA is available in an 8-pin small-outline integrated-circuit (SOIC) package and in a 14-pin thin-shrink small-outline package (TSSOP) and operates over a junction temperature range of -40°C to 125°C.)

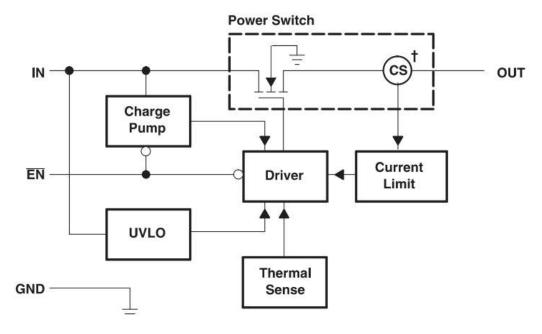


Figure 20: TPS2013A



2 Block Diagram

TIDA-01243 USB-C™ Mini Dock EVM

Block Diagram

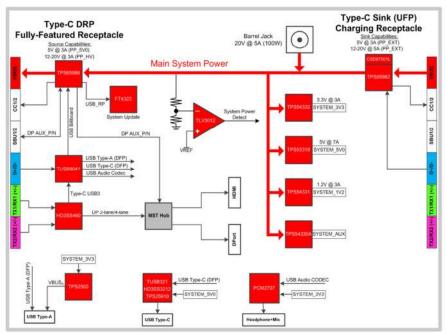


Figure 21: TIDA-01243 Block Diagram

2.1 Highlighted Products

2.1.1 HD3SS460

- Provides MUX Solution for USB Type-CTM Ecosystem Including Alternate Mode (AM)
- Provides Wide Channel Selection Choices Including USBSS and 2 Ch AM, 4 Ch AM
- Compatible with 5 Gbps USB3.1 Gen 1 and AM Including 5.4 Gbps DisplayPort 1.2a
- Compatible for Source/Host and Sink/Device Applications
- Provides Cross-point MUX for Low Speed SBU Pins
- Bidirectional "Mux/De-Mux" Differential Switch
- Supports Common Mode Voltage 0-2V
- Low Power with 1-μA Shutdown and 0.6 mA Active
- Single Supply Voltage VCC of 3.3V ±10%
- Industrial Temperature Range of -40 to 85°C



2.1.2 TUSB321

- USB Type-C Specification 1.1
- Backward Compatible with USB Type-C Specification 1.0
- Supports Up to 3 A of Current Advertisement through dedicated Current Mode pin
- Mode Configuration
 - Host Only DFP (Source)
 - Device Only UFP (Sink)
 - o Dual Role Port DRP
- Channel Configuration (CC)
 - Attach of USB Port Detection
 - Cable Orientation Detection
 - o Role Detection
 - Type-C Current Mode advertisement and detection (Default, Medium, High)
- V_{BUS} Detection
- VCONN Support for Active Cables
- Cable Detection and Direction Control for External Switches
- Supply Voltage: 4.5 V to 5.5 V
- Low Current Consumption
- Industrial Temperature Range of –40 to 85°C

2.1.3 HD3SS3212

- Provides MUX/DEMUX Solution for USB Type-C™ Ecosystem for USB 3.1 Gen 1 and Gen 2 Data Rates
- Compatible With MIPI DSI/CSI, FPDLinkIII, LVDS, and PCIE Gen II, III
- Operates up to 10 Gbps
- Wide –3-dB Differential BW of over 8 GHz
- Excellent Dynamic Characteristics (at 5 GHz)
 - Crosstalk = -32 dB
 - Off Isolation = -19 dB
 - Insertion Loss = -1.6 dB
 - Return Loss = -12 dB
- Bidirectional "Mux/De-Mux" Differential Switch
- Supports Common Mode Voltage 0 to 2 V



- Single Supply Voltage V_{cc} of 3.3 V
- Commercial Temperature Range of 0°C to 70°C (HD3SS3212RKS)
- Industrial Temperature Range of –40°C to 85°C (HD3SS3212IRKS)

2.1.4 TPS65982

- USB Power Delivery (PD) Controller
 - o Mode Configuration for Source (Host), Sink (Device), or Source-Sink
 - Bi-Phase Marked Encoding/Decoding (BMC)
 - o Physical Layer (PHY) Protocol
 - Policy Engine
 - Configurable at Boot and Host-Controlled
- USB Type-C Specification Compliant
 - o Detect USB Cable Plug Attach
 - Cable Orientation and Role Detection
 - o Assign CC and VCONN Pins
 - o Advertise Default, 1.5-A or 3-A Current for 5-V USB Type-C Power
- Port Power Switch
 - o 5-V, 3-A Switch to VBUS for Type-C Power
 - 5-V to 20-V, 3-A Bidirectional Switch to or from VBUS for USB PD Power
 - 5-V, 600-mA Switches for VCONN
 - Overcurrent Limiter, Overvoltage Protector
 - o PD Slew Rate Control and Hard Reset Support
- Port Data Multiplexer
 - USB 2.0 HS Data, UART Data, and Low Speed Endpoint
 - Sideband Use Data for Alternate Modes (DisplayPort and Thunderbolt)
- Power Management
 - Gate Control and Current Sense for External 5-V to 20-V, 5-A Bidirectional NFET Switch
 - Power Supply from 3.3-V or VBUS Source
 - 3.3-V LDO Output for Dead Battery Support
- BGA MicroStar Junior Package
 - o 0.5-mm Pitch
 - o Through-Hole Via Compatible for All Pins
- UL Recognized: E169910 and E339631
- Standards Used: 2367
- IEC Certification: NO88109
 - Standards Used: 60950-1(ed.2);am1;am2



2.1.5 TPD65986

- USB Power Delivery (PD) Controller
 - o Mode Configuration for Source (Host), Sink (Device), or Source-Sink
 - Bi-phase Marked Encoding/Decoding (BMC)
 - Physical Layer (PHY) Protocol
 - Policy Engine
 - o Configurable at Boot and Host-Controlled
- USB Type-C Specification Compliant
 - o Detect USB Cable Plug Attach
 - Cable Orientation and Role Detection
 - o Assign CC and VCONN Pins
 - o Advertise Default, 1.5 A, or 3 A for Type-C Power
- Port Power Switch
 - o 5-V, 3-A Switch to VBUS for Type-C Power
 - o 5-V to 20-V, 3-A Bidirectional Switch to or from VBUS for USB PD Power
 - 5-V, 600-mA Switches for VCONN
 - Over-Current Limiter, Overvoltage Protector
 - Slew Rate Control
 - Hard Reset Support
- Port Data Termination
 - o USB 2.0 Low Speed Endpoint
- Power Management
 - o Power Supply from 3.3 V or VBUS Source
 - o 3.3-V LDO Output for Dead Battery Support
- BGA MicroStar Junior Package
 - o 0.5-mm Pitch
 - Through-Hole Via Compatible for All Pins
- UL Recognized: E169910 and E339631
 - o Standards Used: 2367
- IEC Certification: NO88109
 - Standards Used: 60950-1(ed.2);am1;am2



3 Getting Started Firmware

3.1 How to Program SPI Flash (TPS6598x) using Aardvark SPI Controller

- 3.1.1. Start Total Phase Flash center.
- 3.1.2. Plug Aardvark dongle into Aardvark Header (J17).
- 3.1.3. Plug Aardvark dongle into Aardvark Header (J17).
- 3.1.4. Select "Adapters" => "Add Adapter"
- 3.1.5. The Aardvark dongle connected to the PC running the flash center should appear in pop-up window. Select the dongle.
- 3.1.6. Choose Target via menu option or shortcut icon:
- 3.1.7. Choose "SPI Flash"=> Windbond/NexFlash => W25Q80

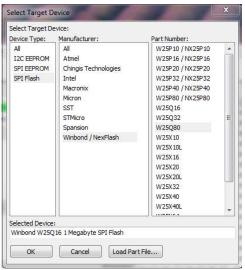


Figure 22 Total Phase Flash Center

3.1.8. Load binary file (USBCMINIDKEVM_v1.7.12_flash_image.bin)

via "Load File" icon: Load File...



3.1.9. Program target (Or Program and verify-optional) via either of these icons: under Operations menu option.



- 3.2.1. Connect USB A-to-USB C cable from PC to the DRP port (J28)
- 3.2.2. TUSB8041 enumerates as a Programming End Point.
- 3.2.3. Invoke TUSB80xx EEPROM Programmer.

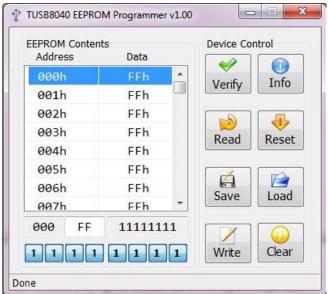


Figure 23 TUSB80xx EEPROM Programmer

- 3.2.4. Click and load in the TUSB8041_POL_HI_ECRON_FULLPWROFF_U1U2On.txt file
- 3.2.5. Click wite to program.
- 3.2.6. Close EEPROM programmer window when programming is done.
 - 3.2.7. Disconnect connection to the host PC then power cycle the dock EVM

3.3 How to Program the Megachip Devices: Bobcat and Pegasus

- 3.3.1. Start Gprobe 7 program
- 3.3.2. Connect Type A-to-micro B Cable with Megachips programming board to Bobcat, should look like the below image



Figure 24 Megachip's Bobcat with Programmer

3.3.3. *First time Set-up Only* – make sure Connection Settings look like the below image. Note the COM7 to UARTO will utilize the COM Port that the Type A-to-Type micro B cable is connected to on the PC.

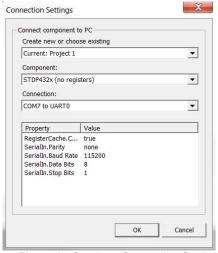


Figure 25 Gprobe 7 Connection Settings

- 3.3.4. Open the Console
- 3.3.5. Navigate to the Bobcat FW file.
 Go to Options→ Commands → Batch Filename →

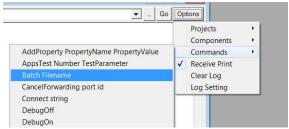


Figure 26 Gprobe 7 Console Batch Command



ISP_UART_FW_LS_PCON_8M_V1_09_Batch_2800.txt → Open → Ok

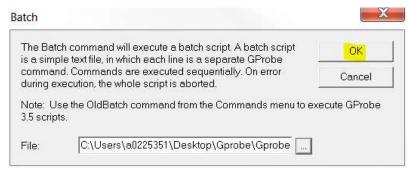


Figure 27 Gprobe 7 Batch Command Program

3.3.6. Once Programming is finished move the programmer cable from Bobcat to Pegasus, orientated as shown below



Figure 28 Megachip's Pegasus with Programmer

- 3.3.7. Navigate to the Pegasus File, PegasusIsp.txt, and click ok to program
- 3.3.8. Once programming is finished disconnected the programmer cable and power cable from the TIDA-01243



4. Getting Started Hardware

- 4.1. Connect the Type-C Enabler Board to the PC with a USB Type-A to USB-B cable and a DisplayPort Cable.
 - 4.2. Connect the Type-C Enabler Board to the TIDA-01243 with a Type-C cable



Figure 29 TIDA-01243 with Type-C Enabler Board

4.3. Confirm that the following 6 LEDS are lit as shown below



Figure 10 TIDA-01243 Bus-powered

4.4. Connect the Dell adapter and confirm that the following 6 LEDS are lit as shown below



Figure 11 TIDA-01243 Self-powered

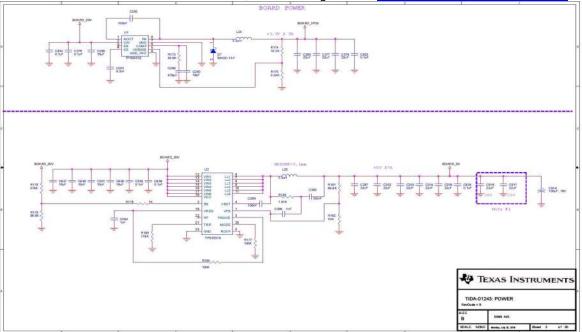
- 4.5. Connect a USB Flash Drive to the TIDA-01243 and confirm that data can be transferred to and from the USB Flash Drive
- 4.6. Connect the HDMI cable to the TIDA-01243 and to a monitor, confirm PC video is displayed on the monitor
- 4.7. Disconnect the HDMI cable and connect a miniDP cable to the TIDA-01243 and to a monitor, confirm PC video is displayed on the monitor.



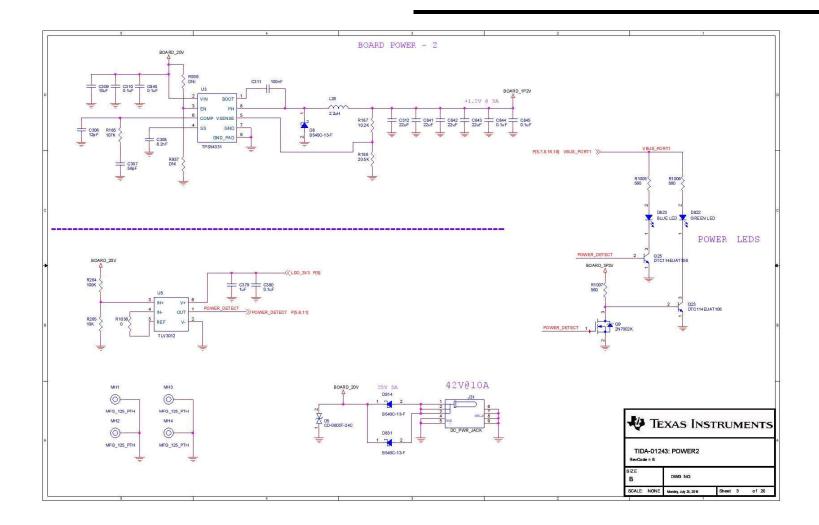
5. Design Files

5.1 Schematics

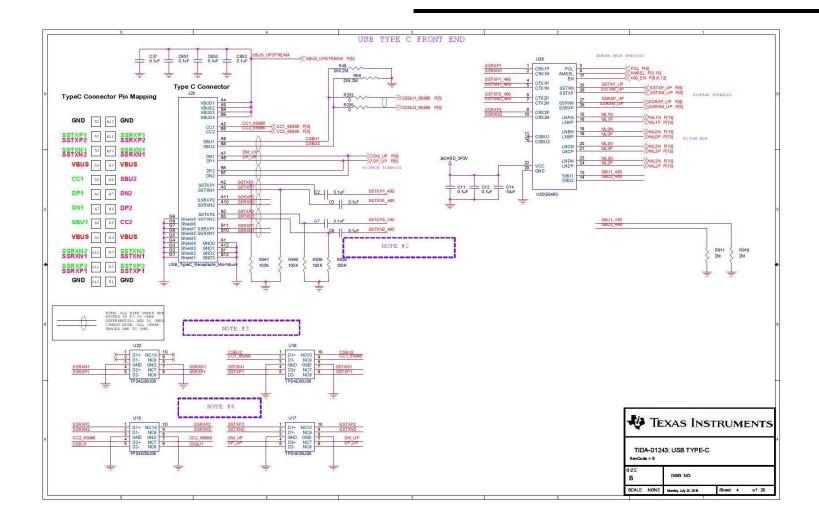
To download the Schematics for each board, see the design files at http://www.ti.com/tool/TIDA-01243



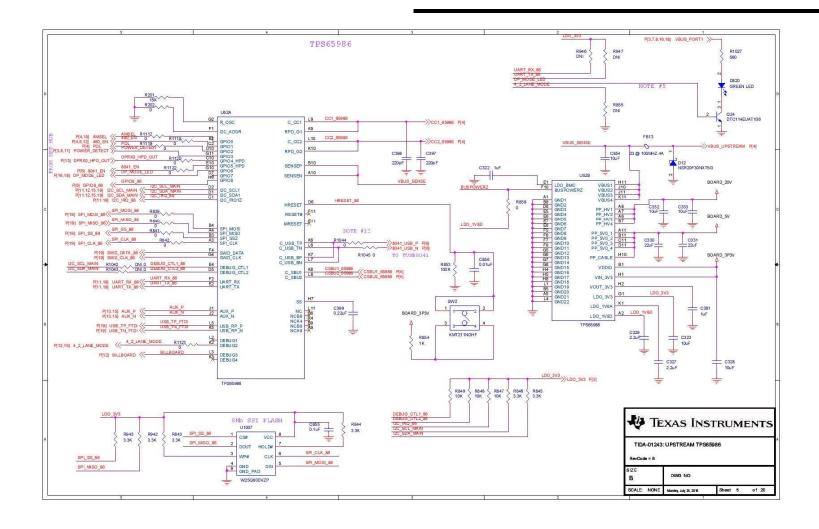




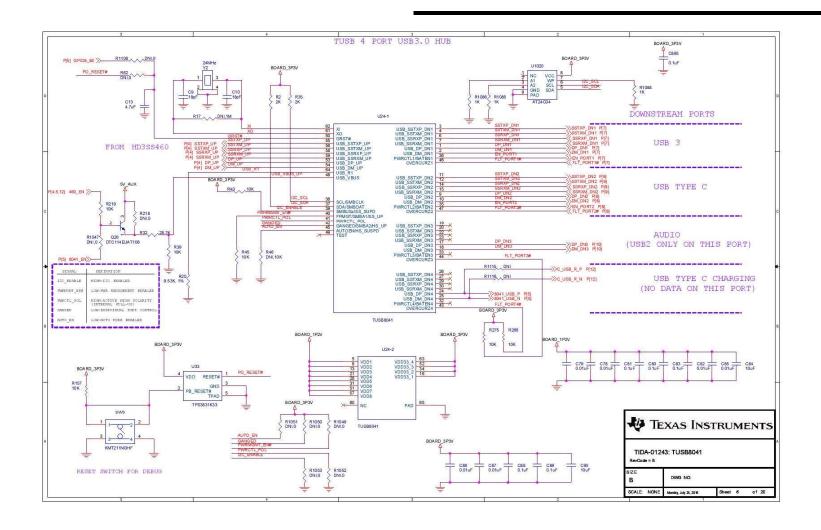




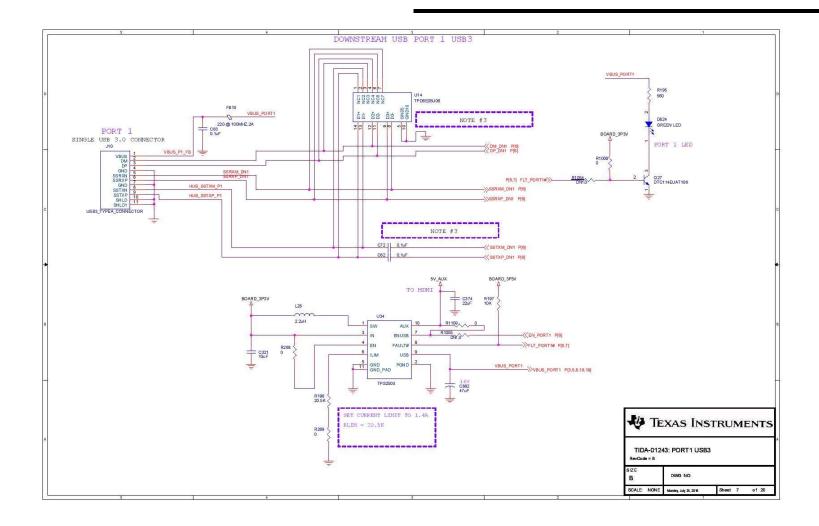




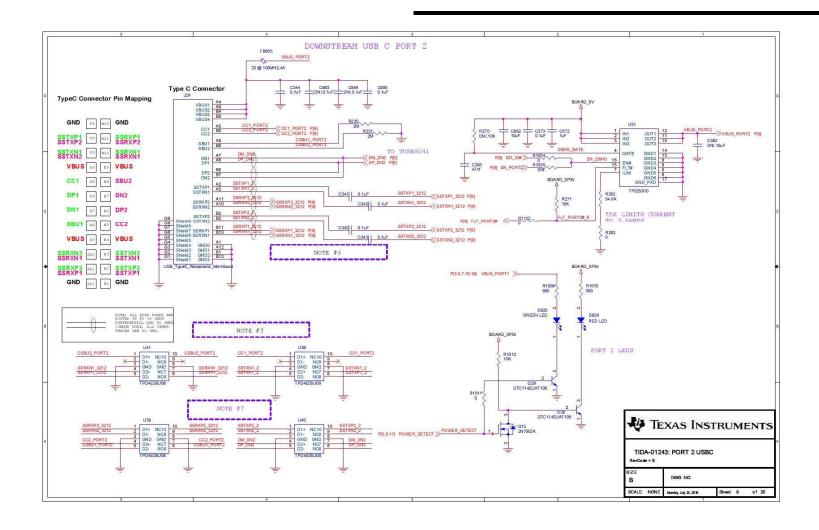


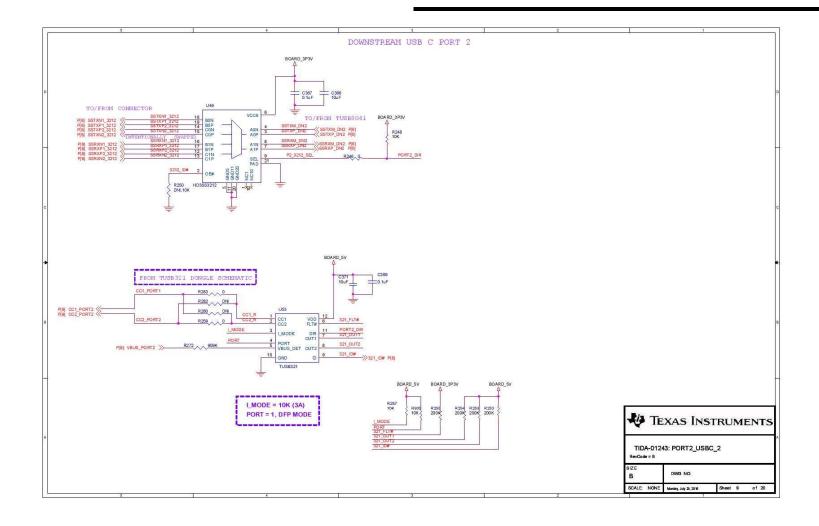




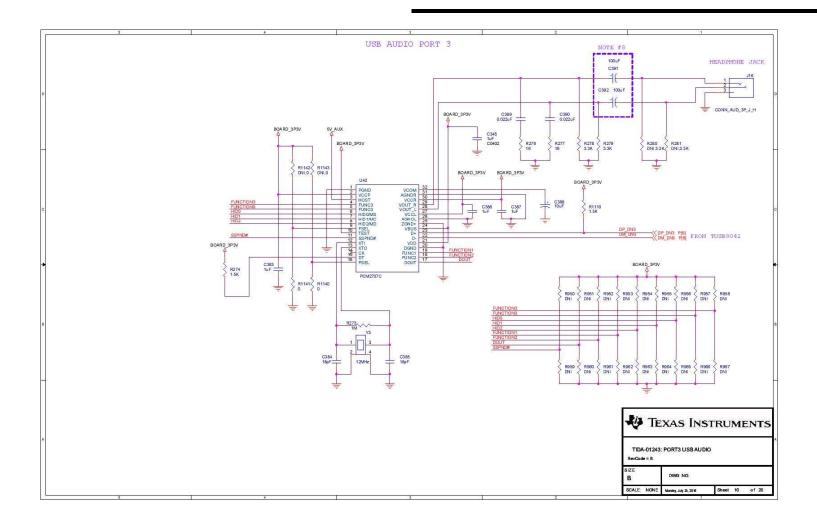


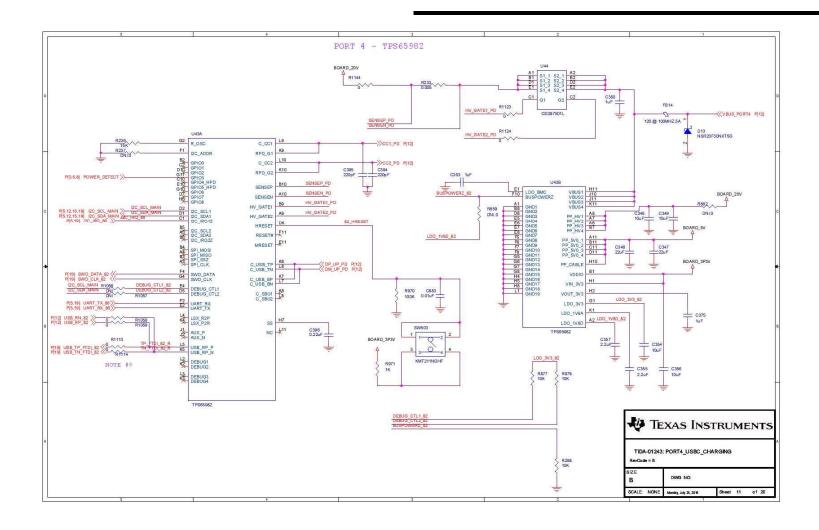




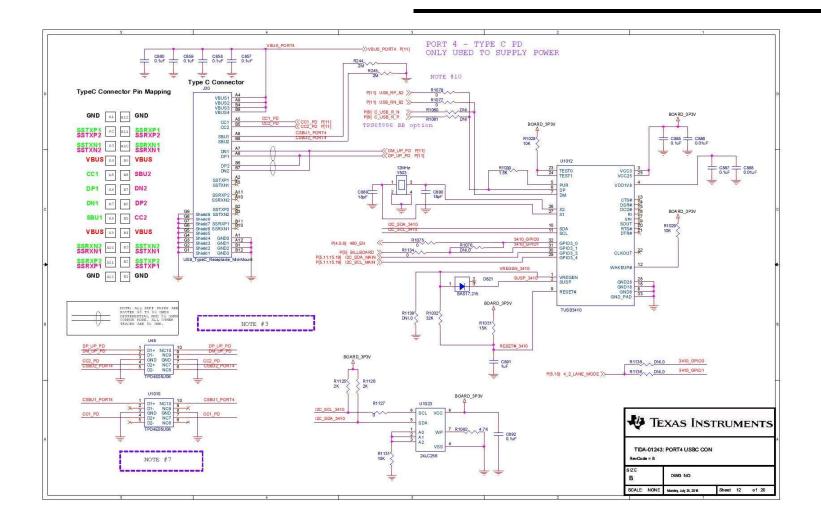




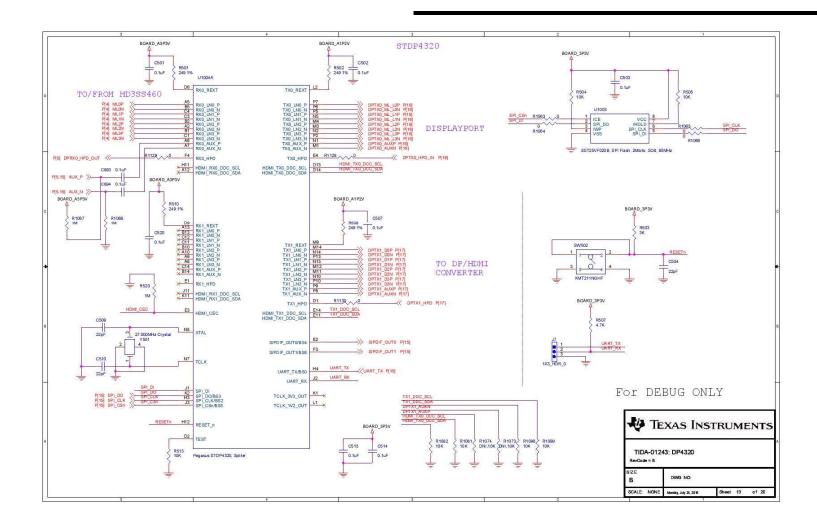




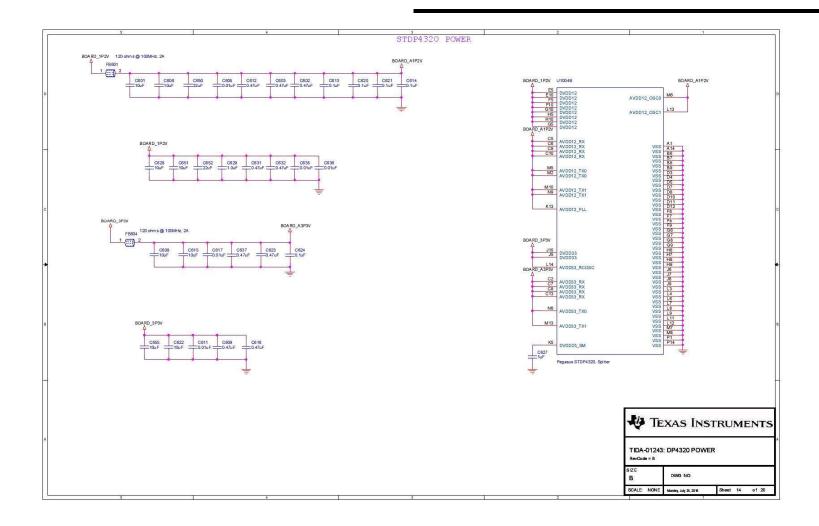




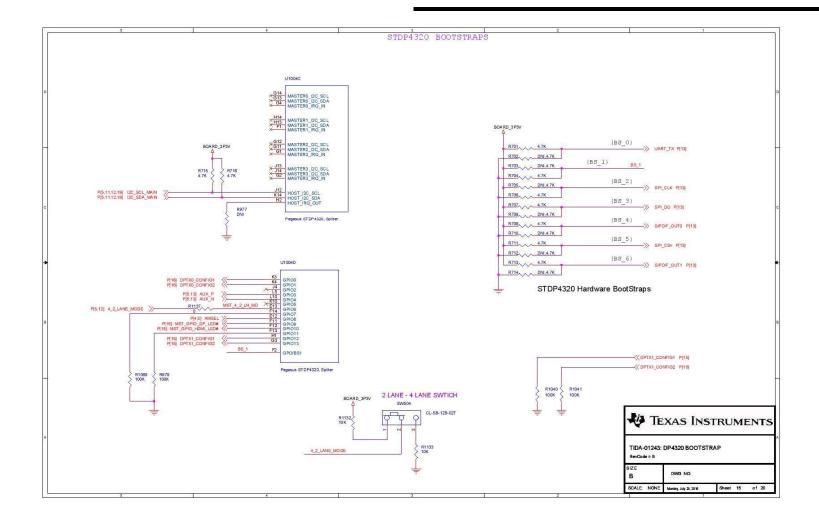




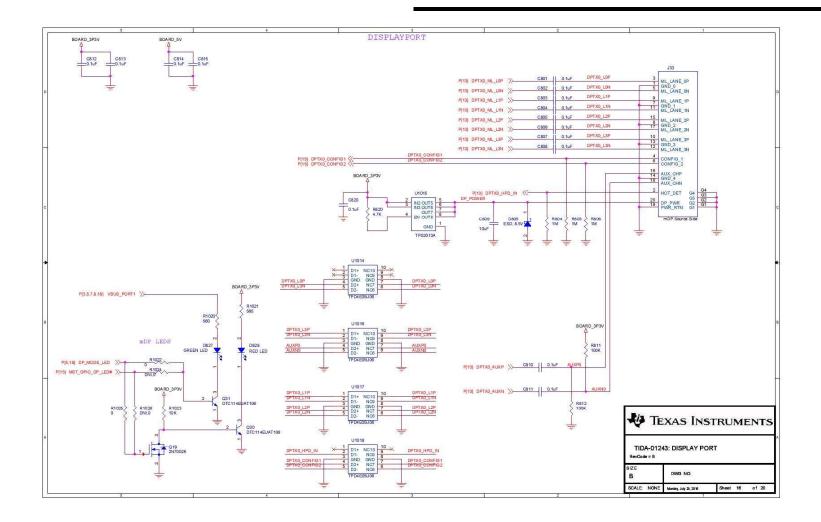


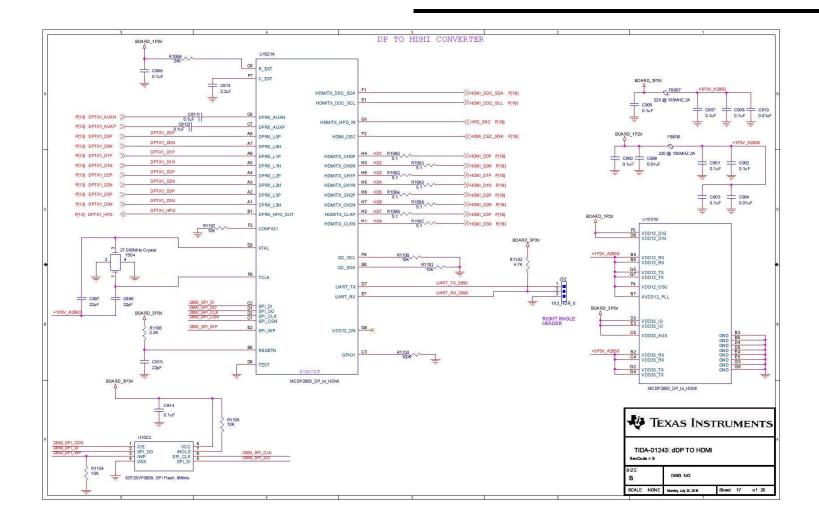






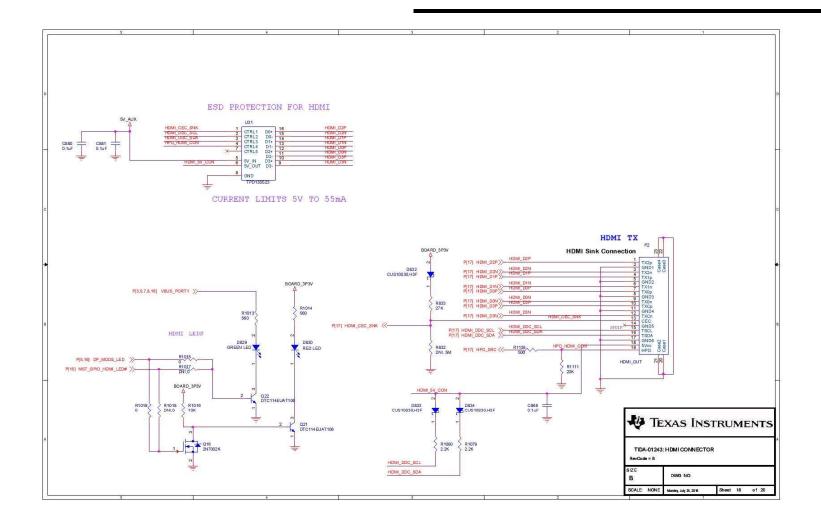






43







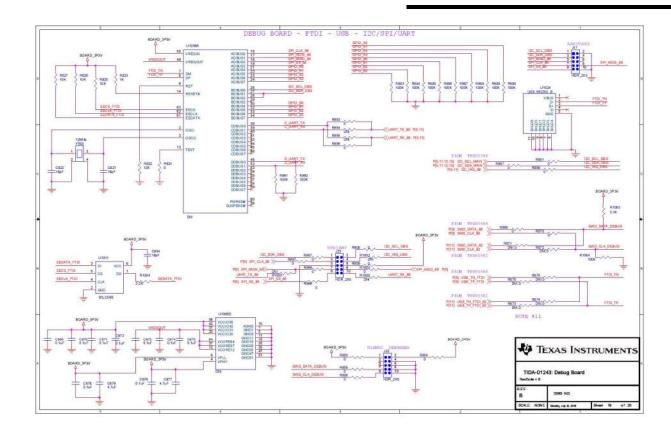


Figure 32: TIDA-01243 Schematic



5.3. Bill of Materials

To download the Bill of Materials for each board, see the design files at http://www.ti.com/tool/TIDA-01243

Table 1: To insert a table caption, right click picture > Insert Caption

	-	2 (2				table caption, right chek					
Line No	Qty	Ref Des	Value	Custo	Package_Cas	Temp Coeff_Power	Toleran	Voltage Rating	Part	Manufacturer	Manufactur
				mer	е		ce		Category		er Part No
				Part							
				Value							
1	17	C2,C3,C7,C8,C62,	0.1μF	0.1uF	0201	X5R	10	16V	Capacitors	TDK	C0603X5R1C
		C72,C295,C340,C3								Corporation	104K
		41,C342,C343,C37									
		6,C833,C834,C835									
		,C839,C855									
2	9	C9,C10,C384,C385	18pF	18pF	0402	COG (NPO)	5	50V	Capacitors	Murata	GRM1555C1
		,C821,C822,C884,								Electronics	H180JA01D
		C889,C890								North America	
3	82	C11,C12,C37,C63,	0.1μF	0.1uF	0402	X7R	10	50V	Capacitors	Murata	GRM155R71
		C80,C81,C83,C88,								Electronics	H104KE14D
		C89,C310,C344,C3								North America	
		67,C369,C373,C38									
		0,C501,C502,C503									
		,C507,C513,C514,									
		C520,C613,C614,C									
		620,C621,C624,C8									
		01,C802,C803,C80									
		4,C805,C806,C807									
		,C808,C810,C811,									
		C812,C813,C814,C									
		815,C820,C840,C8									
		44,C845,C851,C85									
		2,C853,C857,C858									
		,C859,C860,C865,									



		C868,C869,C870,C 871,C872,C873,C8 74,C875,C876,C87 8,C880,C881,C885 ,C887,C892,C893, C894,C895,C898,C 900,C901,C902,C9 03,C905,C907,C90 8,C911,C912,C914									
4	3	C13,C877,C879	4.7μF	4.7uF	0402	X5R	10	6.3V	Capacitors	TDK Corporation	C1005X5R0J 475K
5	8	C14,C84,C90,C323 ,C328,C354,C356, C366	10μF	10uF	0402	X5R	20	6.3V	Capacitors	Samsung	CL05A106M Q5NUNC
6	16	C78,C79,C82,C85, C86,C87,C605,C61 1,C617,C635,C636 ,C886,C888,C899, C904,C910	10000p F	0.01uF	0402	X7R	10	50V	Capacitors	Murata Electronics North America	GRM155R71 H103KA88D
7	11	C288,C301,C309,C 332,C333,C348,C3 49,C836,C837,C83 8,C854	10μF	10uF	0805	X5R	10	25V	Capacitors	Murata Electronics North America	GRM21BR61 E106KA73L
8	1	C289	470pF	470pF	0201	X7R	10	25V	Capacitors	Murata Electronics North America	GRM033R71 E471KA01D
9	1	C290	10pf	10pF	0201	COG	0.5	50V	Capacitors	TDK Corporation	C0603C0G1 H100D



10	2	C291,C308	8200PF	8.2nF	0201	X5R	10	10V	Capacitors	Murata	GRM033R61
										Electronics	A822KA01D
										North America	
11	4	C292,C299,C300,C	0.1μF	100nF	0402	X7R	10	50V	Capacitors	Murata	GRM155R71
		311								Electronics	H104KE14D
										North America	
12	19	C293,C297,C302,C	22μF	22uF	0603	X5R	20	4V	Capacitors	Taiyo Yuden	AMK107BJ2
		303,C304,C305,C3									26MA-T
		12,C330,C331,C34									
		6,C347,C374,C377									
		,C378,C650,C652,									
42	1	C841,C842,C843	40.5	1.5	0503	V7D	10	4617	6	TDV	64 600 47 04 6
13	1	C294	1.0μF	1uF	0603	X7R	10	16V	Capacitors	TDK	C1608X7R1C
14	1	C298	1000pF	1nF	0402	X7R	10	50V	Capacitors	Corporation TDK	105K080AC C1005X7R1H
14	1	C298	1000pr	THE	0402	A/K	10	500	Capacitors	Corporation	102K
15	1	C306	12pF	12pF	0201	COG	5	50V	Capacitors	TDK	C0603C0G1
15	_	C300	1201	1201	0201	600		301	Capacitors	Corporation	H120J030BA
16	1	C307	56pF	56pF	0201	COG (NPO)	5	50V	Capacitors	TDK	C0603C0G1
			300.	306.	0202	(0)			- Capacitors	Corporation	H560J030BA
17	12	C321,C371,C601,C	10μF	10uF	0603	X5R	20	10V	Capacitors	Murata	GRM188R61
		606,C608,C615,C6								Electronics	A106ME69D
		22,C628,C651,C65								North America	
		5,C809,C882									
18	2	C322,C353	1.0μF	1uF	0201	X5R	20	6.3V	Capacitors	TDK	C0603X5R0J
										Corporation	105M
19	5	C327,C329,C355,C	2.2μF	2.2uF	0402	X5R	20	6.3V	Capacitors	TDK	C1005X5R0J
		357,C913								Corporation	225M
20	11	C345,C350,C372,C	1.0μF	1uF	0402	X5R	10	16V	Capacitors	Samsung	CL05A105KO
		375,C379,C381,C3								Electro-	5NNND
		83,C386,C387,C62								Mechanics	
24	0	7,C891	DAII	DNI 10	DAII					America, Inc.	DNII
21	0	C382	DNI	DNI,10	DNI				Undefined	DNI	DNI



				uF					Category		
22	1	C388	10μF	10uF	0805	X7R	10	16V	Capacitors	Samsung	CL21B106KO QNNNE
23	2	C389,C390	0.022μF	0.022u F	0402	X7R	10	25V	Capacitors	Murata Electronics North America	GRM155R71 E223KA61D
24	2	C391,C392	100μF	100uF	D5 H5.4	85°C	20	10V	Capacitors	Panasonic Electronic Components	EEE- 1AA101WR
25	1	C393	47000p F	47nf	0402	X7R	10	25V	Capacitors	Murata Electronics North America	GRM155R71 E473KA88D
26	4	C394,C395,C397,C 398	220pf	220pF	0201	X7R	10	25V	Capacitors	TDK Corporation	C0603X7R1E 221K030BA
27	2	C396,C399	0.22μF	0.22uF	0201	X5R	10	10V	Capacitors	TDK Corporation	C0603X5R1A 224K
28	6	C504,C509,C510,C 896,C897,C915	22pF	22pF	0402	COG (NPO)	5	50V	Capacitors	Taiyo Yuden	UMK105CG2 20JV-F
29	9	C602,C603,C609,C 612,C616,C623,C6 31,C632,C637	0.47μF	0.47uF	0402	X5R	10	10V	Capacitors	Murata Electronics North America	GRM155R61 A474KE15D
30	1	C629	1.0μF	1.0uF	0402	X5R	10	16V	Capacitors	Samsung Electro- Mechanics America, Inc.	CL05A105KO 5NNND
31	2	C856,C883	10000p F	0.01uF	0201	X7R	10	10V	Capacitors	Murata Electronics North America	GRM033R71 A103KA01D
32	1	C862	47μF	47uF	D4 H6.1	105°C	20	16V	Capacitors	Panasonic Electronic Components	EEE- FT1C470AR
33	0	C863,C864	DNI	DNI,0. 1uF	DNI				Undefined Category	DNI	DNI



34	2	C916,C917	22μF	22uF	0805	X5R	10	16V	Capacitors	TDK Corporation	C2012X5R1C 226K
35	1	C918	100μF	100uF, 16V	7343-31 (EIA)	125°C	10	16V	Capacitors	Kemet Electronic Components	T491D107K0 16AT
36	1	D5	DIODE ZENER	CD- 0603T- 24C	0603	1A		47V	Circuit Protection	Bourns Inc	CD0603- T24C
37	4	D7,D8,D814,D831	single	B540C- 13-F	SOD-128	5A		30V	Discrete Semicond uctor Products	NXP Semiconducto rs	PMEG3050E P,115
38	1	D12	Single	NSR20 F30NX T5G	2-XFDFN	2A		30V	Discrete Semicond uctor Products	ON Semiconducto r	NSR20F30NX T5G
39	1	D13	Single	NSR20 F30NX T5G	2-XFDFN	2A		30V	Discrete Semicond uctor Products	ON Semiconducto r	NSR20F30NX T5G
40	1	D805	1 Channel - Bidirecti onal	ESD, 8.5V	ST0201			3V	Circuit Protection	STMicroelectr onics	ESDAVLC8- 1BU2
41	6	D820,D822,D824, D825,D827,D829	LED - Green Clear	GREEN LED	0603	20mA	12	2.1V	Optoelect ronics	Lite-On Inc	LTST- C191GKT
42	1	D821	BAS17,2 15	BAS17, 215	SOT-23-3	200mA		5V	Discrete Semicond uctor Products	NXP Semiconducto rs	BAS17,215



43	1	D823	LED - Ultra Bright Blue Clear	BLUE LED	0603	10mA	5	3.9V	Optoelect ronics	Vishay Semiconducto r Opto Division	TLMB1100- GS08
44	3	D826,D828,D830	LED - Red Clear	RED LED	0603	10mA	2	2V	Optoelect ronics	Lite-On Inc	LTST- C190EKT
45	3	D832,D833,D834	CUS10S 30,H3F	CUS10 S30,H3 F	SOD-323	1A		30V	Discrete Semicond uctor Products	Toshiba	CUS10S30,H 3F
46	3	FB10,FB606,FB60 7	220	220 @ 100M HZ,2A	0603	2A			Filters	Murata Electronics North America	BLM18EG22 1SN1D
47	2	FB13,FB605	23	23 @ 100M HZ,4A	0603	4A			Filters	Taiyo Yuden	FBMJ1608H M230NT
48	1	FB14	120	120 @ 100M HZ,5A	0805	5A			Filters	Samsung	CIS21J121NE
49	2	FB601,FB604	120	120 ohms @ 100M Hz, 2A	0603	2A			Filters	Murata Electronics North America	BLM18PG12 1SN1D
50	2	J7,J32	1 x 3	1X3_H DR 0	0.1"	High Temp			Connector s	Samtec Inc	HTSW-150- 07-G-S
51	1	J10	USB 3.0, Super Speed	USB3_ TYPEA _CON NECTO R	USB - A, Receptacle				Connector s	Amphenol Commercial Products	GSB311131H R



52	1	J16	Mini Jack - 3.5mm_	CONN _AUD_ 3P_J_H	SMT			Connector s	CUI	SJ-3523-SMT
53	3	J17,J22,J23	R/A 2 x 5	HDR_2	0.1x0.1"	High Temp		Connector	Samtec Inc	HTSW-150-
		, ,		X5		5 ,		S		07-G-D
54	3	J28,J29,J30	Recepta cle - Mid mount	USB_T ypeC_ Recept acle_ Mid- Mount	SMT			Connector s	LINTES	AUSB0129
55	1	J31	Power Jack	61400 46600 _DC_P WR_JA CK	Through Hole			Connector s	Foxconn	JPD1135- 509-7F-
56	1	J33	DP3AR0 20SU32 JQ1	MINI_ DISPLA Y_POR T	т/н			Connector s	JAE Electronics	DP3AR020S U32JQ1
57	2	L24,L25	3.3uH	3.3uH	5.48 mm x 5.28 mm x 3.1 mm			Inductors _Coils_Ch okes	Coilcraft	XAL5030- 332MEB
58	1	L26	2.2μΗ	2.2uH	4.0mm x 4.0mm x 2.1mm	5.6A		Inductors _Coils_Ch okes	Coilcraft	XAL4020- 222MEB
59	1	L28	2.2μΗ	2.2uH	7.6mm x 7.6mm x 4.35mm	4.76A	20	Inductors _Coils_Ch okes	Cooper Bussmann	DR74-2R2-R
60	1	P2	HDMI WITH BACK	HDMI_ OUT	19pin - R/A			Connector s	Molex Inc	0471511001



			COVER								
61	4	Q9,Q13,Q16,Q19	N-CH	2N700 2K	SOT-23-3	300mA	350	60V	Discrete Semicond uctor Products	Vishay Siliconix	2N7002K-T1- E3
62	1	Q21	NPN	DTC11 4EUAT 106	SOT-323	50mA		50V	Discrete Semicond uctor Products	ROHM Semiconducto r USA, LLC	DTC114EUA T106
63	10	Q22,Q23,Q24,Q2 5,Q26,Q27,Q28,Q 29,Q30,Q31	NPN	DTC11 4EUAT 106	SOT-323	50mA		50V	Discrete Semicond uctor Products	ROHM Semiconducto r USA, LLC	DTC114EUA T106
64	4	R2,R35,R1125,R1 126	2.00K	2K	0402	1/16W	1	50V	Resistors	Stackpole	RMCF0402F T2K00
65	0	R17	DNI	DNI,1 M	DNI				Undefined Category	DNI	DNI
66	1	R20	9.53K	9.53K, 1%	0402	1/16W	1		Resistors	Vishay Dale	CRCW04029 K53FKED
67	1	R32	28.7K	28.7K	0402	1/16W	1		Resistors	Yageo	RC0402FR- 0728K7L
68	33	R39,R40,R45,R15 7,R182,R197,R219 ,R265,R266,R275, R504,R505,R513, R825,R826,R827, R1012,R1016,R10 23,R1028,R1029,R 1081,R1082,R109 8,R1099,R1100,R1 101,R1104,R1105, R1107,R1131,R11	10.0К	10K	0402	±100ppm/°C	1	0.1W, 1/10W	Resistors	Panasonic Electronic Components	ERJ- 2RKF1002



		32,R1133									
69	0	R46,R1073,R1074	DNI	DNI,10 K	DNI				Undefined Category	DNI	DNI
70	0	R48,R56	DNI	DNI,2 M	DNI				Undefined Category	DNI	DNI
71	0	R62,R218,R871,R 872,R1017,R1018, R1024,R1026,R10 47,R1049,R1050,R 1051,R1052,R105 3,R1054,R1055,R1 076,R1108,R1135, R1136,R1139,R11 42,R1143	DNI	DNI,0	DNI				Undefined Category	DNI	DNI
72	1	R173	49.9K	49.9K	0201	1/20W	1	25V	Resistors	Panasonic Electronic Components	ERJ- 1GEF4992C
73	2	R174,R187	10.2K	10.2K	0201	1/20W	1		Resistors	Panasonic Electronic Components	ERJ- 1GEF1022C
74	1	R175	3.24K	3.24K	0201	1/20W	1		Resistors	Samsung	RC0603F324 1CS
75	1	R176	576K	576K	0201	1/20W	1		Resistors	Panasonic Electronic Components	ERJ- 1GEF5763C
76	6	R177,R184,R938, R939,R940,R941	100K	100K	0201	1/20W	1		Resistors	Yageo America	RC0201FR- 07100KL



77	1	D470	1.001/	11/	0201	4/2014/	1		Desistana	D	EDI
77	1	R178	1.00K	1K	0201	1/20W	1		Resistors	Panasonic	ERJ-
										Electronic	1GEF1001C
	-									Components	
78	1	R179	86.6K	86.6K	0201	1/20W	1		Resistors	Panasonic	ERJ-
										Electronic	1GEF8662C
										Components	
79	1	R180	178K	178K	0201	1/20W	1		Resistors	Panasonic	ERJ-
										Electronic	1GEF1783C
										Components	
80	1	R181	69.8K	69.8K	0402	±100ppm/°C	1	1/10W	Resistors	Vishay Dale	CRCW04026
											9K8FKED
81	1	R183	1.91K	1.91K	0402	1/10W	1		Resistors	Panasonic -	ERJ-
										ECG	2RKF1911X
82	1	R185	107K	107K	0201	1/20W	1		Resistors	Panasonic	ERJ-
										Electronic	1GEF1073C
										Components	
83	1	R186	20.5K	20.5K	0201	1/20W	1		Resistors	Panasonic	ERJ-
						·				Electronic	1GEF2052C
										Components	
84	11	R195,R1005,R100	560	560	0402	1/10W	1	75V	Resistors	Yageo	RC0402JR-
		6,R1007,R1009,R1				-,		, , ,		1 2825	07560RL
		010,R1013,R1014,									0,000
		R1020,R1021,R10									
		27									
85	1	R196	20.5K	20.5K	0402	1/10W	1		Resistors	Panasonic	ERJ-
05	_	NI30	20.51	20.510	0402	1/10**	_		100000	Electronic	2RKF2052X
										Components	ZINNI ZOJZA
86	3	R201,R236,R1031	15.0K	15K	0402	1/16W	1		Resistors	Panasonic	ERJ-
00	3	NZU1,NZ30,N1U31	15.UK	TOV	0402	1/10//	1		Resistors	Electronic	2RKF1502X
											74VLT207Y
										Components	



87	30	R202,R203,R205, R246,R259,R263, R283,R839,R840, R841,R842,R858, R1034,R1044,R10 45,R1058,R1059,R 1077,R1078,R111 2,R1113,R1114,R1 117,R1118,R1119, R1120,R1121,R11 22,R1123,R1124	0.0 (Zero Ohm)	0	0201	1/20W	5	50V	Resistors	Vishay Dale	CRCW02010 000Z0ED
88	2	R230,R231	2.00M	2M	0201	0.05W, 1/20W	5		Resistors	Panasonic Electronic Components	ERJ- 1GEJ205C
89	1	R233	0.005	.005	0805	1/2W	1	±100ppm/°C	Resistors	Bourns Inc.	CRF0805-FX- R005ELF
90	0	R237,R859,R873, R874,R875,R876, R1042,R1043	DNI	DNI,0	DNI				Undefined Category	DNI	DNI
91	4	R244,R245,R910, R911	2.00M	2M	0402	1/16W	1		Resistors	Vishay Dale	CRCW04022 M00FKED
92	10	R248,R257,R271, R288,R847,R848, R849,R877,R878, R935	10.0K	10K	0201	1/20W	1	75V	Resistors	Panasonic Electronic Components	ERJ- 1GEF1002C
93	0	R250,R270	DNI	DNI,10 K	DNI				Undefined Category	DNI	DNI
94	4	R253,R254,R255, R258	200K	200K	0201	1/20W	1		Resistors	Panasonic Electronic Components	ERJ- 1GEF2003C
95	0	R260,R282,R855, R936,R937,R946, R947,R1035,R105	DNI	DNI	DNI				Undefined Category	DNI	DNI



		6,R1057,R1060,R1 061,R1115,R1116								
96	1	R262	54.9K	54.9K	0201	1/20W	1	Resistors	Yageo America	RC0201FR- 0754K9L
97	19	R264,R811,R812, R853,R970,R978, R983,R984,R985, R986,R987,R988, R989,R990,R1040, R1041,R1069,R10 84,R1103	100К	100K	0402	1/16W	1	Resistors	Yageo	RC0402FR- 07100KL
98	42	R268,R269,R824, R869,R870,R897, R898,R901,R903, R904,R905,R906, R907,R908,R909, R993,R996,R997, R998,R999,R1001, R1008,R1011,R10 15,R1019,R1022,R 1025,R1036,R106 3,R1064,R1065,R1 066,R1075,R1109, R1127,R1128,R11 29,R1130,R1134,R 1137,R1140,R114	0.0 (Zero Ohm)	0	0402	1/16W	5	Resistors	Yageo	RCO4O2JR- O7ORL
99	1	R272	909K	909K	0402	1/10W	1	Resistors	Panasonic Electronic Components	ERJ- 2RKF9093X
100	3	R273,R1067,R106 8	1.00M	1M	0402	1/16W	1	Resistors	Vishay Dale	CRCW04021 M00FKED



101	3	R274,R1030,R111 0	1.50K	1.5K	0402	1/16W	1		Resistors	Yageo	RC0402FR- 071K5L
102	2	R276,R277	16	16	0402	1/16W	1		Resistors	Vishay Dale	CRCW04021 6R0FKED
103	3	R278,R279,R1083	3.30K	3.3K	0402	1/16W	1		Resistors	Vishay Dale	CRCW04023 K30FKED
104	0	R280,R281	DNI	DNI,3. 3K	DNI				Undefined Category	DNI	DNI
105	4	R501,R502,R508, R510	249	249 1%	0402	±100ppm/C	1	1/16W	Resistors	Yageo	RC0402FR- 07249RL
106	1	R503	3K	3K	0402	1/16W	1	75V	Resistors	Yageo	RC0402JR- 073K
107	2	R507,R1102	4.70K	4.7K	0603	1/10W	1		Resistors	Rohm Semiconducto r	MCR03ERTF 4701
108	4	R520,R804,R805, R806	1.00M ohm	1M	0603	1/10W	1		Resistors	Yageo	RC0603FR- 071ML
109	11	R701,R704,R706, R707,R709,R711, R713,R715,R716, R820,R1062	4.70K	4.7K	0402	1/16W	1		Resistors	Vishay Dale	CRCW04024 K70FKED
110	0	R702,R703,R705, R708,R710,R712, R714	DNI	DNI,4. 7K	DNI				Undefined Category	DNI	DNI
111	1	R822	12.0K	12K	0402	1/16W	1		Resistors	Yageo	RC0402FR- 0712KL
112	6	R823,R854,R971, R1085,R1086,R10 88	1.00K	1K	0402	1/16W	1		Resistors	ROHM Semiconducto r USA, LLC	MCR01MRTF 1001
113	0	R832	DNI	DNI, 5M	DNI				Undefined Category	DNI	DNI
114	1	R833	27K	27K	0402	1/16W	1	75V	Resistors	Yageo	RC0402FR- 0727KL



115	6	R843,R844,R845, R846,R942,R943	3.3K	3.3K	0201	1/20W	1		Resistors	Panasonic Electronic Components	ERJ- 1GEF3301C
116	0	R862	DNI	DNI,0	DNI				Undefined	DNI	DNI
117	0	R950,R951,R952, R953,R954,R955, R956,R957,R958, R959,R960,R961, R962,R963,R964, R965,R966,R967, R977,R994,R995, R1000,R1002,R10	DNI	DNI	DNI				Category Undefined Category	DNI	DNI
118	2	R991,R992	100K	100K	0603	1/10W	1		Resistors	Yageo	RC0603FR- 07100KL
119	4	R1004,R1079,R10 80,R1106	2.20K	2.2K	0402	1/10W	5		Resistors	Panasonic Electronic Components	ERJ- 2GEJ222X
120	1	R1032	32K	32K	0402	1/16W	1		Resistors	Vishay Dale	TNPW04023 2K0BEED
121	1	R1089	249	249	0402	±100ppm/C	1	1/16W	Resistors	Yageo	RC0402FR- 07249RL
122	8	R1090,R1091,R10 92,R1093,R1094,R 1095,R1096,R109 7	5.1	5.1	0201	1/20W	5		Resistors	Samsung	RC0603J5R1 CS
123	1	R1111	20.0K	20K	0402	1/16W	1		Resistors	Vishay Dale	CRCW04022 0K0FKED
124	1	R1138	500	500	0402	±100ppm/°C	1	1/10W	Resistors	Vishay Dale	PNM0402E5 000BST1
125	1	R1144	0.0 (Zero	0	0805	1/8W	5		Resistors	Yageo	RC0805JR- 070RL



			Ohm)							
126	4	SW2,SW3,SW502, SW503	SPST- NO Off- Mom	KMT21 1NGHF	3.00mm x 2.60mm	0.05A	32V	Switches	C&K Components	KMT211NG HF LFS
127	1	SW504	SPDT ON-ON	CL-SB- 12B- 02T	Gull Wing	0.2A	12V	Switches	Copal Electronics Inc	CL-SB-12B- 01
128	1	U1	TPS543 32DDA	TPS54 332	8-SOIC	3.5A	0.8 ~ 25 V	Integrated Circuits	Texas Instruments	TPS54332DD A
129	1	U2	TPS533 18DQPT	TPS53 318	22-QFN			Integrated Circuits	Texas Instruments	TPS53318DQ PT
130	1	U3	TPS543 31DDA	TPS54 331	8-SOIC PowerPAD			Integrated Circuits	Texas Instruments	TPS54331DD A
131	1	U5	TLV301 2AIDCK	TLV30 12	6-TSSOP			Integrated Circuits	Texas Instruments	TLV3012AID CKR
132	1	U14	TPD6E0 5U06RV ZR	TPD6E 05U06	14-UFDFN		14V	Circuit Protection	Texas Instruments	TPD6E05U06 RVZR
133	14	U15,U16,U17,U22 ,U38,U39,U40,U4 1,U48,U1010,U10 14,U1016,U1017, U1018	TPD4E0 5U06D QAR	TPD4E 05U06	SON-10			Integrated Circuits	Texas Instruments	TPD4E05U06 DQAR
134	1	U24	TUSB80 41RGCR	TUSB8 041	64-VQFN			Integrated Circuits	Texas Instruments	TUSB8041RG CR
135	1	U31	TPD13S 523PW R	TPD13 S523	16-TSSOP			Circuit Protection	Texas Instruments	TPD13S523P WR
136	1	U33	TPS383 1K50DQ NR	TPS38 31K33	4-X2SON			Integrated Circuits	Texas Instruments	TPS3831K50 DQNR
137	1	U34	TPS250 ODRCR	TPS25 00	10-SON			Integrated Circuits	Texas Instruments	TPS2500DRC R



138	1	U36	HD3SS4	HD3SS	28-QFN			Integrated	Texas	HD3SS460R
			60	460	•			Circuits	Instruments	HRR
139	1	U42	PCM27	PCM27	TQFP-32			Integrated	Texas	PCM2707CPJ
			07	07C				Circuits	Instruments	TR
140	1	U43	TPS659	TPS65	96-BGA			Integrated	Texas	TPS65982AB
			82ABZQ	982				Circuits	Instruments	ZQZR
			ZR							
141	1	U44	CSD875	CSD87	10-PICOSTAR			Discrete	Texas	CSD87501L
			01L	501L				Semicond	Instruments	
								uctor Products		
142	1	U49	HD3SS3	HD3SS	20-VQFN			Integrated	Texas	HD3SS3212I
142		049	212IRKS	3212	20-VQ11V			Circuits	Instruments	RKSR
			R	3212				Circuits	moti differenti	mon
143	1	U51	TPS259	TPS25	QFN-16			Integrated	Texas	TPS25910RS
			10RSA	910				Circuits	Instruments	Α
144	1	U52	TPS659	TPS65	96-BGA			Integrated	Texas	TPS65986AB
			86	986				Circuits	Instruments	ZQZR
145	1	U53	TUSB32	TUSB3	12-XQFN			Integrated	Texas	TUSB321RW
			1RWBR	21				Circuits	Instruments	BR
146	1	U1003	SST25V	SST25	8-SOIC			Integrated	Silicon Storage	SST25VF020
			F020B-	VF020				Circuits	Technology	B-80-4I-SAE
			80-4I- SAE	B, SPI Flash,						
			SAE	2Mbits						
				, SO8,						
				80MHz						
147	1	U1004	STDP43	Pegasu	172-BGA			Integrated	Megachip	STDP4320
			20	s				Circuits		
				STDP4						
				320,						
				Spliter						
148	1	U1006	FT4232	FT423	64-LQFP		3.0 V ~ 3.6 V	Integrated	Parallax	FT4232HL



			HL	2H					Circuits		
149	1	U1007	8M (1M x 8)	W25Q 80DVZ P	8-WSON (6X5 mm)			2.7 V ~ 3.6 V	Integrated Circuits	Winbond Electronics	W25Q80DVZ PIG
150	1	U1011	93LC56 B-I/OT	93LC5 6B	SOT-23-6				Integrated Circuits	Microchip Technology	93LC56B- I/OT
151	1	U1012	TUSB34 10IRHB	TUSB3 410	32-QFN				Integrated Circuits	Texas Instruments	TUSB3410IR HB
152	1	U1015	TPS201 3AD	TPS20 13A	8-SOIC				Integrated Circuits	Texas Instruments	TPS2013AD
153	1	U1020	4KBIT Eeprom	AT24C 04	8-UDFN 2.0mm x 3.0mm	400kHz, 1MHz	45128	1.7 V ~ 3.6 V	Integrated Circuits	Atmel	AT24C04D- MAHM
154	1	U1021	MCDP2 850	MCDP 2850_ DP_to HDMI	64-BGA				Integrated Circuits	Megachip	MCDP2850
155	1	U1022	SST25V F080B- 80-4I- SAE	SST25 VF080 B, SPI Flash, 8Mbits	8-SOIC				Integrated Circuits	Silicon Storage Technology	SST25VF080 B-80-4I-SAE
156	1	U1023	24LC25 6T-I/SN	24LC2 56	8-SOIC			2.5V ~ 5.5V	Integrated Circuits	Microchip Technology	24LC256T- I/SN
157	0	U1024	USB - micro AB Pin 1 left	USB_ MICRO _B	DNI				Connector s	Hirose	ZX62D-AB- 5P8
158	1	Y2	24MHz	24MHz	4-SMD (2.50mm x 2.00mm)	-20°C ~ 70°C	30		Crystals & Oscillators	TXC CORPORATION	8Z- 24.000MAAJ -T
159	3	Y3,Y502,Y503	12MHz	12MHz	4-SMD (2.50mm x	-20°C ~ 70°C	30		Crystals & Oscillators	TXC CORPORATION	8Z- 12.000MAAJ



					2.00mm)					-Т
160	2	Y501,Y504	27MHZ	27.000 MHz Crystal	4-SMD	20PF	50	Crystals & Oscillators	ECS Inc	ECS-270-20- 33-TR
161	1	РСВ						PCB BOARD	ANY	TID-01243



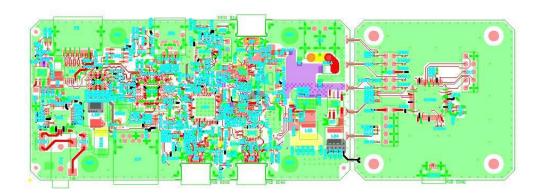
5.4. PCB Layout Recommendations

5.4.1. Layout Prints

To download the Layout Prints for each board, see the design files at http://www.ti.com/tool/tida-01243



ART FILM - TOP



BCARS NAME;	BOARD REV.	RB10;	100 HUMBER:
USB TYPE C DOCK	3.0	18871	129072
ALL ANYWORK LAYERS VIEWED FROM TOP	LAYER 1	- TOP SIDE	

ART FILM - TOP



ART FILM - BOTTOM

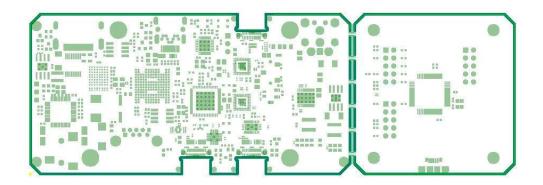




ART FILM - BOTTOM



ART FILM - SMASK_TOP

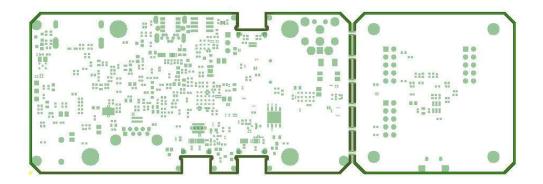




ART FILM - SMASK_TOP



ART FILM - SMASK_BOT





ART FILM - SMASK_BOT



ART FILM - SILK_TOP

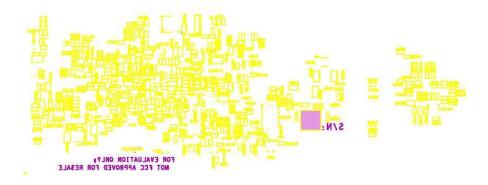




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ART FILM - SILK_BOT

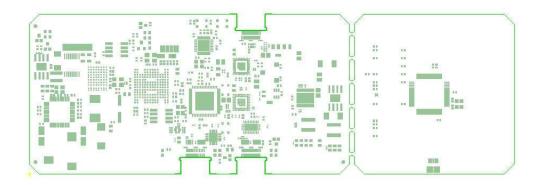




ART FILM - SILK_BOT



ART FILM - PMASK_TOP

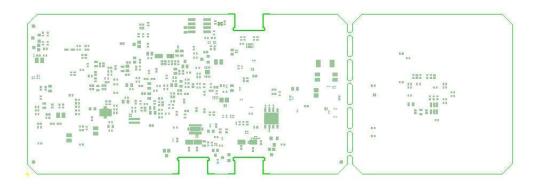




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ART FILM - PMASK_BOT





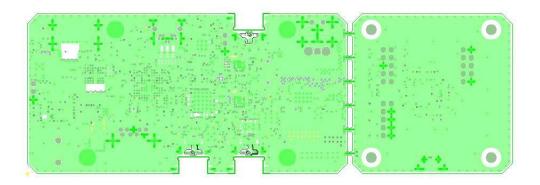
ART FILM - PMASK_BOT







ART FILM - L2_GND

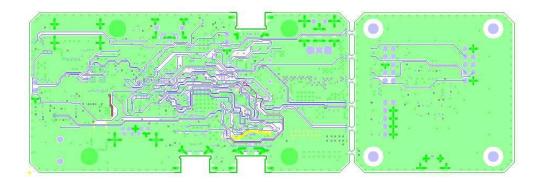




ART FILM - L2_GND



ART FILM - L3_SIG

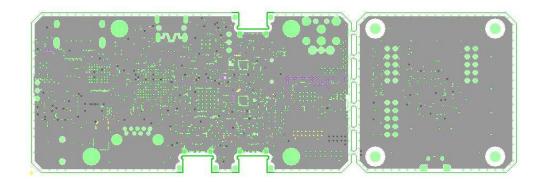




ART FILM - L3_SIG



ART FILM - L4_PWR

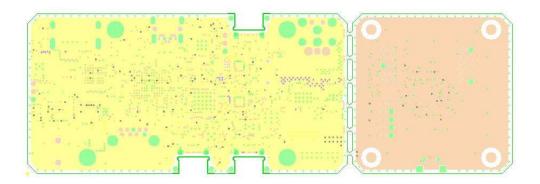




ART FILM - L4_PWR



ART FILM - L7_PWR

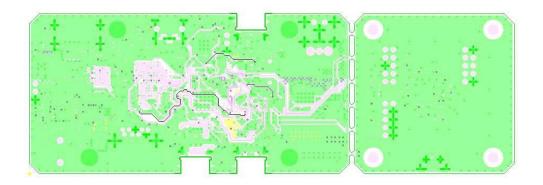




ART FILM - L7_PWR



ART FILM - L8_SIG

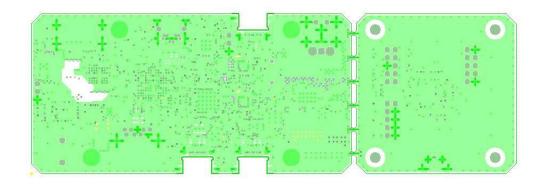




ART FILM - L8_SIG



ART FILM - L9_GND

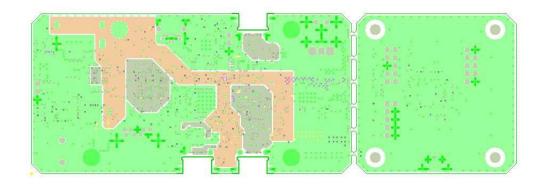




ART FILM - L9_GND



ART FILM - L5_VBUS_GND

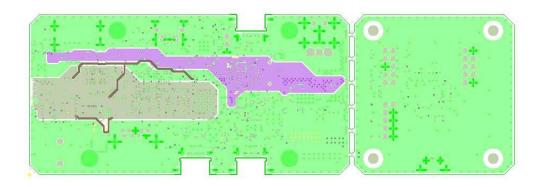




ART FILM - L5_VBUS_GND



ART FILM - L6_1P2V_GND





ART FILM - L6_1P2V_GND

Figure33: TIDa-01243 Layout



5.5. Altium Project

To download the Altium project files for each board, see the design files at http://www.ti.com/tool/tida-01243

5.6. Layout Guidelines

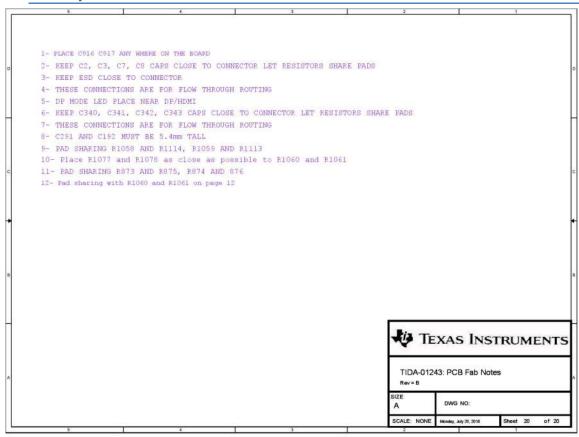


Figure 34: To insert a caption, right click picture > Insert Caption



5.7. Gerber files

To download the Gerber files for each board, see the design files at http://www.ti.com/tool/tida-01243

5.8. Assembly Drawings

To download the Assembly Drawings for each board, see the design files at http://www.ti.com/tool/DESIGNNUMBER

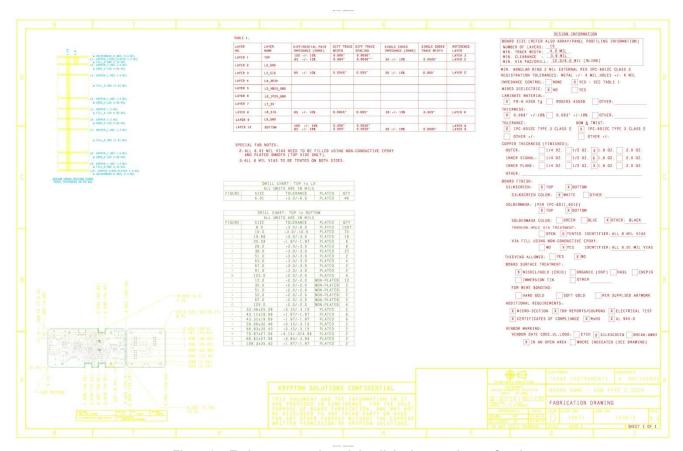


Figure 35: To insert a caption, right click picture > Insert Caption

5.9. Software Files

To download the software files for this reference design, please see the link at http://www.ti.com/tool/tida-01243

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